

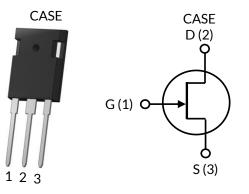


Silicon Carbide (SiC) JFET - EliteSiC, Power N-Channel, TO-247-3L, 1200 V, 66 mohm

Rev. B, January 2025

DATASHEET

UJ3N120065K3S



Part Number	Package	Marking
UJ3N120065K3S	TO-247-3L	UJ3N120065K3S



Description

UnitedSiC offers the high-performance G3 SiC normally-on JFET transistors. This series exhibits ultra-low on resistance ($R_{DS(ON)}$) and gate charge (Q_G) allowing for low conduction and switching loss. The device normally-on characteristics with low $R_{DS(ON)}$ at V_{GS} = 0 V is also ideal for current protection circuits without the need for active control, as well as for cascode operation.

Features

- Typical on-resistance $R_{DS(on),typ}$ of 66m Ω
- Voltage controlled
- Maximum operating temperature of 175°C
- Extremely fast switching not dependent on temperature
- Low gate charge
- Low intrinsic capacitance
- RoHS compliant

Typical applications

- Over Current Protection Circuits
- DC-AC Inverters
- Switch mode power supplies
- Power factor correction modules
- Motor drives
- Induction heating





Maximum Ratings

Parameter	Symbol	Test Conditions	Value	Units
Drain-source voltage	V _{DS}		1200	V
Gate-source voltage	V _{GS} –	DC	-20 to +3	V
	V GS	AC ¹	-30 to +20	V
Continuous drain current ²	1	T _C = 25°C	34	А
	I _D	T _C = 100°C	25	А
Pulsed drain current ³	I _{DM}	T _C = 25°C	90	А
Power dissipation	P _{tot}	T _C = 25°C	254	W
Maximum junction temperature	$T_{J,max}$		175	°C
Operating and storage temperature	TJ,TSTG		-55 to 175	°C
Max. lead temperature for soldering, 1/8" from case for 5 seconds	TL		250	°C

1. +20V AC rating applies for turn-on pulses <200ns applied with external R_G > 1 Ω .

2. Limited by $T_{J,max}$

3. Pulse width t_p limited by $T_{J,max}$

Thermal Characteristics

Parameter	Symbol	Test Conditions	Value			Units
Parameter			Min	Тур	Max	Units
Thermal resistance, junction-to-case	$R_{ ext{ heta}JC}$			0.45	0.59	°C/W











Electrical Characteristics (T_J = +25°C unless otherwise specified)

Typical Performance - Static

Parameter	Symbol	Test Conditions	Value			Unite
Parameter			Min	Тур	Max	– Units
Drain-source breakdown voltage	BV _{DS}	V_{GS} =-20V, I_{D} =1mA	1200			V
Total drain leakage current	I _{DSS}	V _{DS} =1200V, V _{GS} =-20V, T _J =25°C		5	30	- μΑ
		V _{DS} =1200V, V _{GS} =-20V, T _J =175°C		56		
Total gate leakage current	1	V _{GS} =-20V, T _J =25°C		0.1	50	μA
	I _{GSS}	V _{GS} =-20V, T _J =175°C		1		μA
Drain-source on-resistance	R _{DS(on)}	V _{GS} =2V, I _D =10A, T _J =25°C		55		mΩ
		V _{GS} =0V, I _D =10A, T _J =25°C		66	90	
		V _{GS} =2V, I _D =10A, T _J =175°C		122		
		V _{GS} =0V, I _D =10A, T _J =175°C		142		
Gate threshold voltage	V _{G(th)}	V_{DS} =5V, I_{D} =35mA	-9.3	-6.6	-4.7	V
Gate resistance	R _G	f=1MHz, open drain		2.6		Ω





Typical Performance - Dynamic

Parameter	Symbol	Test Conditions	Value			Unite
			Min	Тур	Max	- Units
Input capacitance	C _{iss}	1/-100/(1/-20)/		1008		
Output capacitance	C _{oss}	- V _{DS} =100V, V _{GS} =-20V - f=100kHz		100		pF
Reverse transfer capacitance	C _{rss}	1-100KHZ		95		
Effective output capacitance, energy related	C _{oss(er)}	V_{DS} =0V to 800V, V_{GS} =-20V		56		pF
C _{OSS} stored energy	E _{oss}	V _{DS} =800V, V _{GS} =-20V		18		μJ
Total gate charge	Q _G	– V _{DS} =800V, I _D =25A, –		114		nC
Gate-drain charge	Q_{GD}	$V_{\rm DS} = -18V \text{ to } 0V$		75		
Gate-source charge	Q_{GS}	VG5 10V 100V		16		
Turn-on delay time	t _{d(on)}			32		- ns
Rise time	t _r	V _{DS} =800V, I _D =25A, Gate		43		
Turn-off delay time	$t_{d(off)}$	Driver =-18V to 0V, $R_G=1\Omega$, Inductive Load, FWD: UJ2D1215T $T_J=25^{\circ}C$		19		
Fall time	t _f			16		
Turn-on energy	E _{ON}			785		
Turn-off energy	E_{OFF}			150		μJ
Total switching energy	E _{TOTAL}			935		
Turn-on delay time	t _{d(on)}	V_{DS} =800V, I_D =25A, Gate Driver =-18V to 0V, R_G =1 Ω , Inductive Load, FWD: UJ2D1215T T_J =150°C		28		ns
Rise time	t _r			42		
Turn-off delay time	$t_{d(off)}$			18		
Fall time	t _f			15		
Turn-on energy	E _{ON}			730		
Turn-off energy	E _{OFF}			146		μJ
Total switching energy	E _{TOTAL}			876		





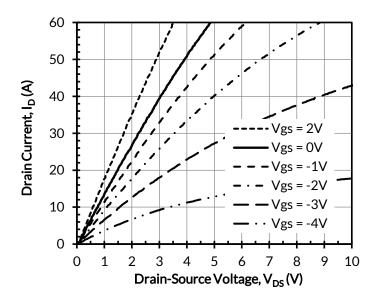
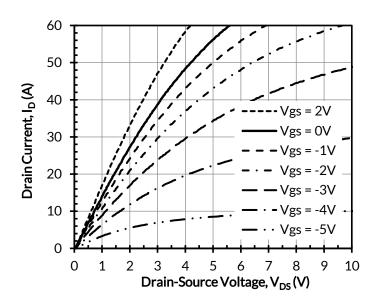


Figure 1. Typical output characteristics at $T_{\rm J}$ = - 55°C, tp < 250 μs



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Figure 2. Typical output characteristics at $T_J = 25^{\circ}C$, tp < 250 μ s

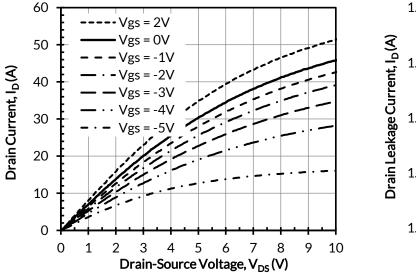


Figure 3. Typical output characteristics at T_J = 175°C, tp < 250 μ s

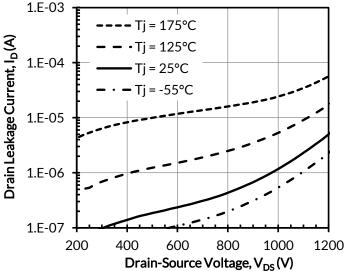
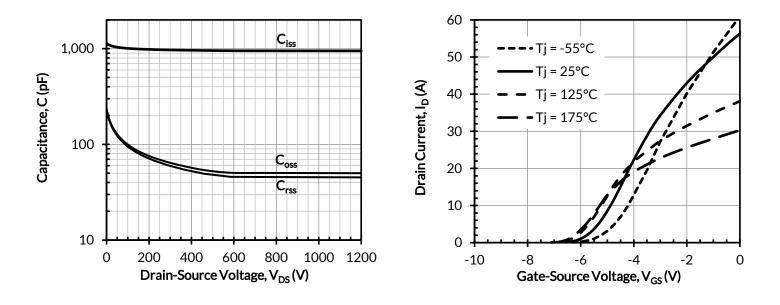


Figure 4. Typical drain-source leakage at V_{GS} = -20V





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Figure 5. Typical capacitances at f = 100kHz and V_{GS} = -20V

Figure 6. Typical transfer characteristics at V_{DS} = 5V

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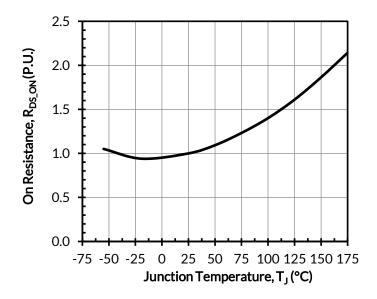


Figure 7. Normalized on-resistance vs. temperature at V_{GS} = 0V and $I_{\rm D}$ = 10A

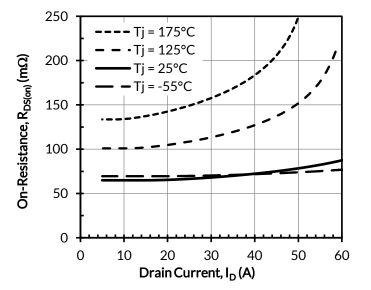


Figure 8. Typical drain-source on-resistances at V_{GS} = 0V





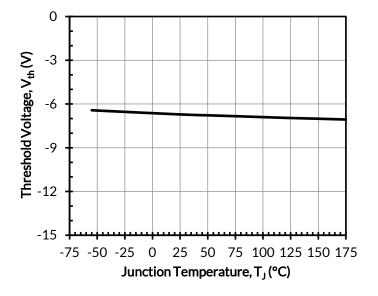


Figure 9. Threshold voltage vs. junction temperature at V_{DS} = 5V and I_{D} = 35mA

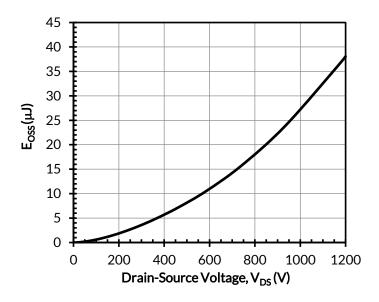


Figure 10. Typical stored energy in C_{OSS} at V_{GS} = -20V

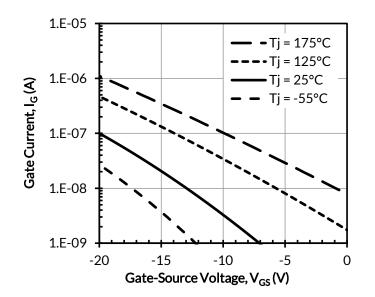


Figure 11. Typical gate leakage at $V_{DS} = 0V$

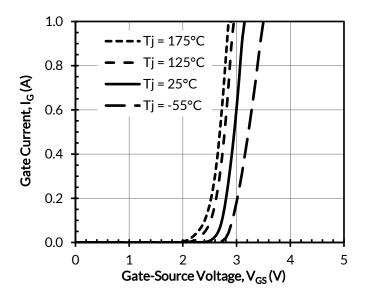
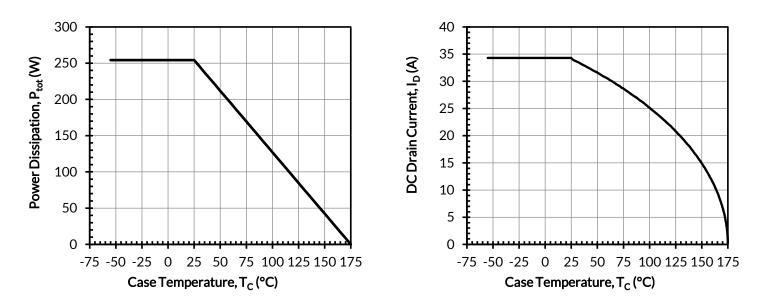


Figure 12. Typical gate forward current at V_{DS} = 0V





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Figure 13. Total power Dissipation

Figure 14. DC drain current derating

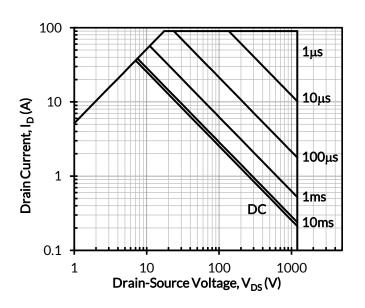
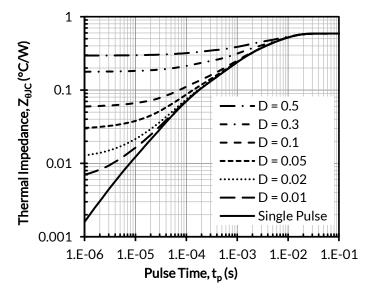


Figure 15. Safe operation area at $T_C = 25^{\circ}$ C, Parameter t_p



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Figure 16. Maximum transient thermal impedance

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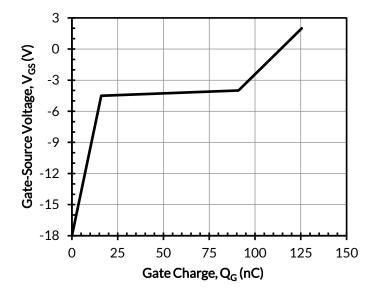


Figure 17. Typical gate charge at V_{DS} = 800V and I_{D} = 25A

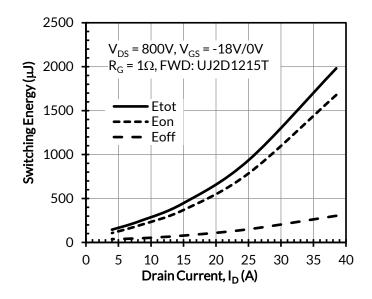


Figure 18. Clamped inductive switching energy vs. drain current at $T_J = 25^{\circ}C$

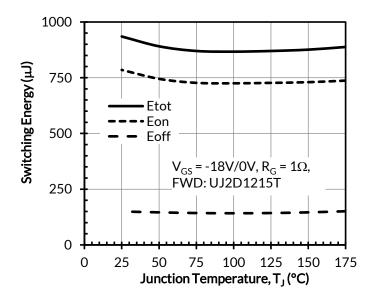


Figure 19. Clamped inductive switching energy vs. junction temperature at V_{DS} = 800V and I_{D} = 25A

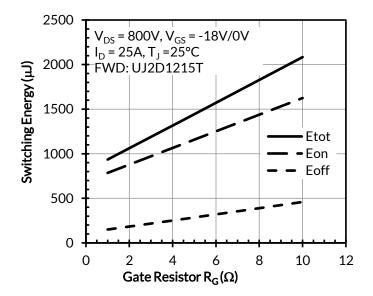


Figure 20. Clamped inductive switching energy vs. gate resistor $\rm R_{\rm G}$







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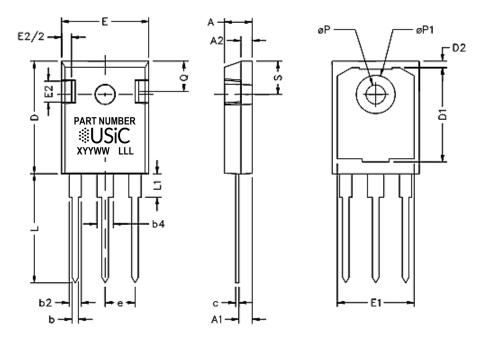
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TO-247-3L PACKAGE OUTLINE, PART MARKING AND TUBE SPECIFICATIONS

PACKAGE OUTLINE



SYM	INCHES		MILLIN	NETERS	
	MIN	MAX	MIN	МАХ	
A	0.185	0.209	4.699	5.309	
A1	0.087	0.102	2.21	2.61	
A2	0.059	0.098	1.499	2.489	
b	0.039	0.055	0.991	1.397	
b2	0.065	0.094	1.651	2.388	
b4	0.102	0.135	2.591	3.429	
С	0.015	0.035	0.381	0.889	
D	0.819	0.845	20.803	21.463	
D1	0.515	-	13.081	-	
D2	0.02	0.053	0.508	1.346	
E	0.61	0.64	15.494	16.256	
е	0.214	BSC 5.		4 BSC	
E1	0.53	-	13.462	-	
E2	0.135	0.157	3.429	3.988	
L	0.78	0.8	19.812	20.32	
L1	-	0.177	-	4.496	
ØР	0.14	0.144	3.556	3.658	
ØP1	0.278	0.291	7.061	7.391	
Q	0.212	0.244	5.385	6.198	
S	0.243	3 BSC	6.17 BSC		



PART MARKING

PART NUMBER SUSSE XYYWW LLL

PART NUMBER = REFER TO DS_PN DECODER FOR DETAILS

X = ASSEMBLY SITE YY = YEAR WW = WORK WEEK LLL = LOT ID

PACKING TYPE

ANTI-STATIC TUBE

QUANTITY / TUBE : 30 UNITS

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